

APPENDIX IV

STATUTORY AND GENERAL INFORMATION

A. FURTHER INFORMATION ABOUT OUR GROUP

1. Incorporation

Our Company was incorporated in the PRC as a limited liability company on November 13, 2009 and was converted into a joint stock limited company on September 26, 2018. Our Company completed the listing of our A Shares on the Shanghai Stock Exchange STAR Market (SHSE: 688123) in December 2019. For further details, see “History and Corporate Structure — Major Shareholding Changes of Our Company” in this document.

Our registered office address is located at Building 10, No. 1761 Zhangdong Road, China (Shanghai) Pilot Free Trade Zone (中國(上海)自由貿易試驗區張東路1761號10幢). We were registered as a non-Hong Kong company in Hong Kong under Part 16 of the Companies Ordinance on February 4, 2026, and our principal place of business in Hong Kong is at 46/F, Hopewell Centre, 183 Queen’s Road East, Wanchai, Hong Kong. Ms. HO Wing Nga has been appointed as our authorized representative for acceptance of service of process and notices on behalf of our Company in Hong Kong, and their correspondence address is the same as our place of business in Hong Kong.

As the Company was established in the PRC, its operations are subject to the relevant laws and regulations of Mainland China. A summary of the relevant provisions of our Articles of Association is set out in Appendix III to this document.

2. Changes in Share Capital of Our Company

Save as disclosed below, there has been no alteration in our share capital within two years immediately preceding the date of this document.

In April 2024, due to the adoption of the 2021 and 2022 Restricted Stock Incentive Plans and completion of share transfer registration, the total share capital of our Company increased by 526,175 A Shares.

In August 2024, our Company repurchased a total of 1,586,993 A Shares, and as a result, the total share capital of our Company decreased by 1,586,993 A Shares.

In September 2024, due to the exercise of the 2021 and 2022 Restricted Stock Incentive Plans and completion of share transfer registration, the total share capital of our Company increased by 309,725 A Shares.

In January 2025, due to the exercise of the 2021 and 2023 Restricted Stock Incentive Plans and completion of share transfer registration, the total share capital of our Company increased by 296,600 A Shares.

In April 2025, due to the exercise of the 2022 and 2023 Restricted Stock Incentive Plans and completion of share transfer registration, the total share capital of our Company increased by 397,275 A Shares.

In September 2025, due to the exercise of the 2021, 2022 and 2023 Restricted Stock Incentive Plans and completion of share transfer registration, the total share capital of our Company increased by 155,225 A Shares.

In May 2026, due to the exercise of the 2021, 2022 and 2023 Restricted Stock Incentive Plans and completion of share transfer registration, the total share capital of our Company increased by 631,525 A Shares.

After the above changes in share capital, as of the Latest Practicable Date, our Company’s total share capital is 158,902,569 A Shares.

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3. Further Information about Our Major Subsidiaries

Details of our major subsidiaries are set out in “History and Corporate Structure — Our Major Subsidiaries” and Note 2 to the Accountants’ Report as set out in Appendix I to this document.

Save as disclosed in “History and Corporate Structure — Our Major Subsidiaries”, there has been no alteration in the registered capital of our subsidiaries within the two years immediately preceding the date of this document.

4. Resolutions Passed by Our Shareholders’ General Meeting of Our Company in Relation to the [REDACTED]

Pursuant to the meeting of the Shareholders held on January 16, 2026, the following resolutions, among others, were duly passed:

- (i) the [REDACTED] by our Company of H Shares with a nominal value of RMB1.00 each and the [REDACTED] of such H Shares on the Stock Exchange;
- (ii) the number of H Shares to be [REDACTED] prior to the exercise of the [REDACTED] shall not exceed [REDACTED] of the enlarged share capital of our Company upon completion of the [REDACTED]; and an [REDACTED] for no more than [REDACTED] of the aforementioned number of H Shares [REDACTED] pursuant to the [REDACTED] shall be granted to the [REDACTED];
- (iii) subject to the completion of the [REDACTED], the Articles of Association, which shall become effective on the [REDACTED], shall be conditionally adopted; and the Board and its authorized persons shall be authorized to amend the Articles of Association in accordance with any comments from the relevant regulatory authorities; and
- (iv) the authorization of the Board and its authorized persons to handle all matters relating to, among other things, the [REDACTED] and the [REDACTED] and [REDACTED] of the H Shares.

B. FURTHER INFORMATION ABOUT OUR BUSINESS

1. Summary of Material Contracts

The following is the contract (not being contracts entered into in the ordinary course of business) entered into by any member of our Group within the two years immediately preceding the date of this document that are or may be material:

- (i) the [REDACTED].

2. Material Intellectual Property Rights

Save as disclosed below, as of the Latest Practicable Date, there were no other intellectual property rights which are or may be material in relation to our business.

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(a) Trademarks

As of the Latest Practicable Date, our Group had registered the following trademarks which we consider to be or may be material to our business:

No.	Trademark	Class	Registered Owner	Registration Number	Place of Registration	Expiry Date
1. . . .		9	Our Company	58480066	PRC	May 06, 2032
2. . . .	GTag	9	Our Company	14840387	PRC	July 13, 2035
3. . . .	GIANTEC	9	Our Company	10496339	PRC	May 20, 2034
4. . . .		9	Our Company	10496332	PRC	April 06, 2033
5. . . .		9	Shanghai Judong Semiconductor Co., Ltd.* (上海聚棟半導體有限公司) (“Shanghai Judong”)	75967063	PRC	August 27, 2034
6. . . .	文显通	9	Our Company	86986314	PRC	February 20, 2036
7. . . .	Voixtell	9	Our Company	86965951	PRC	February 20, 2036

(b) Patents

As of the Latest Practicable Date, we had registered the ownership of and/or had the right to use the following patents which we consider to be or may be material to our business:

No.	Registered Owner	Patent	Type	Patent Number	Issue Date	Place of Registration
1. . . .	Our Company	A constant current driver and its method of use thereof (一種恒流驅動電路及使用方法)	Invention	CN202311646218.X	April 28, 2026	PRC
2. . . .	Our Company	Control tooling, production workstation and method for configuring PID parameters of camera motors (攝像頭馬達配置PID參數的控制工裝、生產工站及方法)	Invention	CN202211083255.X	March 17, 2026	PRC
3. . . .	Our Company	Bootstrap half-bridge driver chip common-mode voltage slew rate tolerance test device and method (自舉型半橋驅動器共模電壓變化率耐受測試裝置及方法)	Invention	CN202011494935.1	November 01, 2024	PRC

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No.	Registered Owner	Patent	Type	Patent Number	Issue Date	Place of Registration
4. . . .	Our Company	A pop-noise-free high-voltage Class D audio power amplifier system and its power-on startup method (一種無pop-noise高壓D類音頻功放系統及其上電啟動方法)	Invention	CN202011443274.X	September 20, 2024	PRC
5. . . .	Our Company	A method for correcting nonlinearity at both ends of the magnetic field of a closed-loop voice coil motor by extracting error method (一種提取誤差法修正閉環音圈馬達磁場兩端非線性的方法)	Invention	CN202110987840.1	August 13, 2024	PRC
6. . . .	Our Company	A method for correcting nonlinearity in the zero magnetic region of closed-loop voice coil motor magnets (一種修正閉環音圈馬達磁鐵零磁區非線性的方法)	Invention	CN202110987198.7	April 23, 2024	PRC
7. . . .	Our Company	Dynamic error elimination method for DACs to improve signal dynamic input range (提高信號動態輸入範圍的數模轉換器的動態誤差消除方法)	Invention	CN202011353465.7	March 01, 2024	PRC
8. . . .	Our Company	Device and method for reducing dynamic device matching resources in audio DACs (減小音頻數模轉換器中動態器件匹配資源的裝置和方法)	Invention	CN202010051882.X	February 09, 2024	PRC
9. . . .	Our Company	High-voltage level shifting circuit and high-voltage level shifting system (高壓電平轉換電路及高壓電平轉換系統)	Invention	CN202010811424.1	February 09, 2024	PRC
10. . .	Our Company	A continuous-time integrator applicable to temperature sensors (一種可用於溫度傳感器的連續時間積分器)	Invention	CN201910335378.X	June 09, 2023	PRC
11. . .	Our Company	A device and method for measuring voice coil motor parameters (一種測量音圈馬達參數的裝置及方法)	Invention	CN202010973538.6	June 09, 2023	PRC

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No.	Registered Owner	Patent	Type	Patent Number	Issue Date	Place of Registration
12. . .	Our Company	A detection device for stator inductance variation of three-phase brushless DC motors (一種三相無刷直流電機定子電感變化檢測裝置)	Invention	CN202011494940.2	October 11, 2022	PRC
13. . .	Our Company	A bootstrap charge pump high-voltage power supply generation circuit (一種自舉電荷泵高壓電源產生電路)	Invention	CN202010888254.7	November 30, 2021	PRC
14. . .	Our Company	Voice coil motor control algorithm with short stabilization time, large damping coefficient and high cycle fault tolerance (穩定時間短阻尼係數大周期容錯高的音圈馬達控制算法)	Invention	CN201910334496.9	September 07, 2021	PRC
15. . .	Our Company	A fractional signal amplification device and method applicable to temperature sensors (一種可用於溫度傳感器的小數信號放大裝置及方法)	Invention	CN201910368347.4	February 09, 2021	PRC
16. . .	Our Company	Voice coil motor damping control circuit (音圈馬達阻尼控制電路)	Invention	CN201910369039.3	January 26, 2021	PRC
17. . .	Our Company	A demodulation circuit for wireless receivers (一種無線接收器的解調電路)	Invention	CN201910506699.1	January 26, 2021	PRC
18. . .	Our Company	A temperature sensor calibration method resistant to reverse Early effect (一種抗反向厄利效應的溫度傳感器校準方法)	Invention	CN201811287166.0	December 22, 2020	PRC
19. . .	Our Company	A voice coil motor control method with short stabilization time and wide applicable damping coefficient range (一種穩定時間短適用阻尼係數範圍廣的音圈馬達控制方法)	Invention	CN201910368369.0	December 22, 2020	PRC
20. . .	Our Company	Programming failure detection circuit and self-test method for contactless card chips (用於非接觸卡類芯片的編程失敗檢測電路及自檢測方法)	Invention	CN201711215516.8	October 30, 2020	PRC
21. . .	Our Company	A bias circuit (一種偏置電路)	Invention	CN201811118804.6	October 30, 2020	PRC

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No.	Registered Owner	Patent	Type	Patent Number	Issue Date	Place of Registration
22. . .	Our Company	A fast high-precision low-temperature-drift strong pull-down current generation circuit (一種快速的高精度低溫漂強下拉電流產生電路)	Invention	CN201811141487.X	October 30, 2020	PRC
23. . .	Our Company	An S-box masking method for SMS4 (一種 SMS4 的 S 盒掩碼方法)	Invention	CN201711248215.5	September 18, 2020	PRC
24. . .	Our Company	A high-precision temperature sensor calibration method and circuit (一種高精度溫度傳感器校準方法及電路)	Invention	CN201811203133.3	September 01, 2020	PRC
25. . .	Our Company	A voice coil motor control system and method introducing damping coefficient (一種引入阻尼係數的音圈馬達控制系統及其方法)	Invention	CN201910368325.8	July 10, 2020	PRC
26. . .	Our Company	A real-time load current detection system (一種負載電流實時探測系統)	Invention	CN201810619848.0	June 02, 2020	PRC
27. . .	Our Company	A method and device for testing EEPROM cell current in contactless IC cards (一種測試非接觸式 IC 卡中 EEPROMcell – 電流的方法及裝置)	Invention	CN201610756857.5	June 25, 2019	PRC
28. . .	Our Company	Fast power-on detection and configuration method and device for contactless IC card chips (非接觸 IC 卡的芯片快速上電檢測和配置方法及裝置)	Invention	CN201610661871.7	May 17, 2019	PRC
29. . .	Our Company	Shaping signal control method for camera voice coil motor actuators (相機音圈馬達執行器的整形信號控制方法)	Invention	CN201610182558.5	July 13, 2018	PRC
30. . .	Our Company	DES system resistant to side-channel attacks with cyclic iteration and method for implementing remappable SBOX (可循環疊代抗側信道攻擊的 DES 系統及實現可重映射 SBOX 方法)	Invention	CN201510040323.8	July 06, 2018	PRC
31. . .	Our Company	A rail-to-rail operational amplifier (一種軌到軌運算放大器)	Invention	CN201510148931.0	April 27, 2018	PRC

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No.	Registered Owner	Patent	Type	Patent Number	Issue Date	Place of Registration
32. . .	Our Company	A system design method for reconfigurable active metal defense layers (一種可重構的主動金屬防禦層的系統設計方法)	Invention	CN201510040369.X	January 19, 2018	PRC
33. . .	Our Company	Low-power adjustable frequency oscillator (低功耗可調頻振盪器)	Invention	CN201410812616.9	November 17, 2017	PRC
34. . .	Our Company	An efficient public key encryption engine (一種高效的公鑰加密引擎)	Invention	CN201510040249.X	September 19, 2017	PRC
35. . .	Our Company	Charge pump circuit suitable for low-voltage operation (適合低電壓操作的電荷泵電路)	Invention	CN201510285461.2	September 19, 2017	PRC
36. . .	Our Company	Shaping signal control method with high clock cycle fault tolerance rate (高時鐘周期容錯率的整形信號控制方法)	Invention	CN201510040282.2	July 28, 2017	PRC
37. . .	Our Company	Simple charge pump circuit suitable for low-voltage operation (適合低電壓操作的簡單電荷泵電路)	Invention	CN201510285462.7	July 11, 2017	PRC
38. . .	Our Company	A low-temperature-drift trimming circuit for amplifier offset voltage trimming (一種用於放大器失調電壓修調的低溫漂修調電路)	Invention	CN201310238489.1	April 06, 2016	PRC
39. . .	Our Company	Protection method for RFID systems (射頻識別系統的保護方法)	Invention	CN201310011430.9	January 27, 2016	PRC
40. . .	Our Company	Self-calibrating buffer amplifier and resistor trimming network in voice coil motor driver chips (音圈馬達驅動器中的自校準緩衝放大器及電阻修整網絡)	Invention	CN201310152041.8	December 09, 2015	PRC
41. . .	Our Company	A bidirectional current rectifier circuit and its current rectification method (一種雙向電流修整電路及其電流修整方法)	Invention	CN201310179565.6	October 21, 2015	PRC
42. . .	Our Company	Power supply circuit for switching power converters (開關電源變換器的電源電路)	Invention	CN201310011305.8	July 22, 2015	PRC
43. . .	Our Company	A new enable control circuit for power management systems (一種用於電源管理系統的新型使能控制電路)	Invention	CN201210481082.7	January 07, 2015	PRC

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No.	Registered Owner	Patent	Type	Patent Number	Issue Date	Place of Registration
44. . .	Our Company	Memory and its operation method (存儲器及其操作方法)	Invention	CN201110211551.9	December 24, 2014	PRC
45. . .	Our Company	Output current segment compensation circuit for LED driver circuits (LED驅動電路的輸出電流分段補償電路)	Invention	CN201210016939.8	December 17, 2014	PRC
46. . .	Our Company	Serial non-volatile memory and method for releasing memory write protection (串列非易失性存儲器及解除存儲器寫保護的方法)	Invention	CN201110350626.1	November 26, 2014	PRC
47. . .	Our Company	Switching power supply controller (開關電源控制器)	Invention	CN201210448457.X	October 15, 2014	PRC
48. . .	Our Company	Switching power supply controller and its current control terminal short-circuit protection method (開關電源控制器及其電流控制端短路保護方法)	Invention	CN201110259867.5	August 27, 2014	PRC
49. . .	Our Company	An LED driver system (一種發光二極體驅動系統)	Invention	CN201010251146.5	November 06, 2013	PRC
50. . .	Our Company	A low-cost effective iterative multi-order digital filtering method and device (一種低成本有效疊代多階數字濾波方法及裝置)	Invention	CN201010251130.4	November 06, 2013	PRC
51. . .	Our Company	A self-test device and self-test method for successive approximation ADCs (一種用於逐步接近型模數轉換器的自測裝置和自測方法)	Invention	CN201010251150.1	September 04, 2013	PRC
52. . .	Our Company	Switching power supply controller and its valley switching method (開關電源控制器及其谷底切換方法)	Invention	CN201110091586.3	April 10, 2013	PRC
53. . .	Our Company	Switching power supply controller circuit and switching power supply system (開關電源控制器電路及開關電源系統)	Invention	CN200910197709.4	January 09, 2013	PRC
54. . .	Giantec Semiconductor (Nanjing) Co., Ltd. (聚辰半導體(南京)有限公司) (“Giantec Nanjing”)	A self-detection method for voice coil motor parameters (一種音圈馬達參數自檢測方法)	Invention	CN201811592975.2	January 26, 2021	PRC

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No.	Registered Owner	Patent	Type	Patent Number	Issue Date	Place of Registration
55. . .	Shanghai Judong	Mode conversion circuit (模式轉換電路)	Invention	CN202510214615.2	July 11, 2025	PRC
56. . .	Shanghai Judong	Current test circuit and test method (電流測試電路及測試方法)	Invention	CN202510214616.7	June 24, 2025	PRC
57. . .	Shanghai Judong	One-time turn-on power-on detection circuit (一次開啟式上電檢測電路)	Invention	CN202111666691.5	April 25, 2025	PRC
58. . .	Shanghai Judong	Initialization data import method (初始化數據導入方法)	Invention	CN202210365609.3	February 25, 2025	PRC
59. . .	Our Company	A relaxation oscillator circuit (一種張弛振盪器電路)	Utility Model	CN202420655946.0	February 14, 2025	PRC
60. . .	Our Company	A motor driver chip base plate and base plate welding structure for camera modules (一種攝像頭模組的電機驅動芯片底板和底板焊接結構)	Utility Model	CN202322995118.X	July 05, 2024	PRC
61. . .	Our Company	A width-compact semiconductor packaging structure (一種寬度緊湊型半導體封裝結構)	Utility Model	CN202323074599.7	June 28, 2024	PRC
62. . .	Our Company	An automatic test verification device for NOR-FLASH memory (一種NOR-FLASH存儲器自動測試驗證裝置)	Utility Model	CN202322472288.X	May 17, 2024	PRC
63. . .	Our Company	A reliability simultaneous test device for camera motor driver chips (一種攝像頭馬達驅動芯片的可靠性同測裝置)	Utility Model	CN202322760068.7	May 17, 2024	PRC
64. . .	Our Company	An automatic test verification device (一種自動測試驗證裝置)	Utility Model	CN202021726194.0	April 23, 2021	PRC
65. . .	Our Company, Giantec Semiconductor (Suzhou) Co., Ltd. (聚辰半導體(蘇州)有限公司)	A serial peripheral interface working mode conversion circuit (一種串行外圍設備接口工作模式轉換電路)	Utility Model	CN202420441057.4	November 01, 2024	PRC
66. . .	Shanghai Judong	An edge grinding device for circuit board processing (一種電路板加工用磨邊裝置)	Utility Model	CN202222644695.X	February 03, 2023	PRC
67. . .	Shanghai Judong	A packaging structure for LED light-emitting diodes (一種LED發光二極體的封裝結構)	Utility Model	CN202222509107.1	February 03, 2023	PRC

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No.	Registered Owner	Patent	Type	Patent Number	Issue Date	Place of Registration
68. . .	Shanghai Judong	A waterproof packaging shell for integrated circuits (一種集成電路防水型封裝外殼)	Utility Model	CN20222249577.9	February 03, 2023	PRC
69. . .	Shanghai Judong	A fault alarm mechanism and packaging equipment (一種故障報警機構及封裝設備)	Utility Model	CN20222153308.2	February 03, 2023	PRC
70. . .	Shanghai Judong	An environmentally friendly LED underground light (一種環保型的LED地埋燈)	Utility Model	CN202221953235.9	February 03, 2023	PRC
71. . .	Shanghai Judong	An integrated circuit board with waterproof structure (一種具有防水結構的集成電路板)	Utility Model	CN20222337358.6	January 31, 2024	PRC
72. . .	Our Company	Chip packaging form (WLCSP-6) (芯片封裝形式 (WLCSP-6))	Design	CN202330721642.0	July 26, 2024	PRC
73. . .	Our Company	Memory Array and method of operating the same	Invention	US8,482,980 B2	July 9, 2013	US
74. . .	Our Company	Switching Power Controller and System	Invention	US8,416,596 B2	April 9, 2013	US
75. . .	Our Company	Reversible write-protection for non-volatile semiconductor memory device	Invention	US8,843,695 B2	September 24, 2014	US
76. . .	Our Company	Apparatus and method for driving a voice coil motor of a camera lens	Invention	US9,049,366 B2	June 2, 2015	US
77. . .	Our Company	Charge Pump Circuit Suitable for low voltage operation	Invention	US9,509,213 B1	November 29, 2016	US
78. . .	Our Company	System and method for one-wire non-volatile memory	Invention	US12,450,111 B2	October 21, 2025	US

(c) Software Copyrights

As of the Latest Practicable Date, our Group had registered the following software copyrights which we consider to be material to our business:

No.	Name	Registered Owner	Place of Registration	Registration Number	Registration Date
1. . . .	GT9881 Chip Batch Automated Testing Software (GT9881 芯片批量自動化測試軟件)	Our Company	PRC	2024SR2205132	November 10, 2023
2. . . .	GT9881 Cycling Software (GT9881 Cycling 軟件)	Our Company	PRC	2024SR2052225	May 08, 2023
3. . . .	Encryption Software Based on GUC Smart Card Chip (基於聚辰智能卡芯片的加密軟件)	Our Company	PRC	2024SR0726677	December 24, 2023

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No.	Name	Registered Owner	Place of Registration	Registration Number	Registration Date
4. . . .	EE&Flash Cycling Test Host Computer Software (EE&Flash Cycling 測試上位機軟件)	Our Company	PRC	2023SR1805297	August 15, 2023
5. . . .	Debug Test Kernel Chip Automated Testing Platform (Debug Test Kernel 芯片自動化測試平台)	Our Company	PRC	2023SR1429221	May 06, 2023
6. . . .	GT2932cos Smart Card Operating System (GT2932cos 智能卡作業系統)	Our Company	PRC	2023SR1311307	October 24, 2022
7. . . .	GT COS System (GT COS 系統)	Our Company	PRC	2020SR0197534	December 05, 2017
8. . . .	New Version 2926cos Software (新版 2926cos 軟件)	Our Company	PRC	2020SR0190398	August 06, 2019
9. . . .	GTCL Chip Testing System (GTCL 芯片測試系統)	Our Company	PRC	2019SR1076058	May 20, 2018

(d) Composition Designs

As of the Latest Practicable Date, our Group had registered in the PRC the following copyrights which we consider to be material to our business:

No.	Registration Number	Composition Design	Composition Design Owner	Issue Date
1. . .	BS.255007841	GT5623B Memory Chip (GT5623B 儲存芯片)	Our Company	April 1, 2026
2. . .	BS.255007833	GT5626 Memory Chip (GT5626 儲存芯片)	Our Company	April 1, 2026
3. . .	BS.25500785X	GT5274B Memory Chip (GT5274B 儲存芯片)	Our Company	April 1, 2026
4. . .	BS.255006349	GT5953 Memory Chip (GT5953 儲存芯片)	Our Company	March 13, 2026
5. . .	BS255000049	GT6608MCU Chip (GT6608MCU 芯片)	Our Company	June 20, 2025
6. . .	BS245012435	GT6605MCU Chip (GT6605MCU 芯片)	Our Company	June 13, 2025
7. . .	BS245007903	GT5625 Memory Chip (GT5625 儲存芯片)	Our Company	December 13, 2024
8. . .	BS245007911	GT5235 Temperature Sensor (GT5235 溫度傳感器)	Our Company	December 13, 2024
9. . .	BS245002022	GT9786V Driver Chip (GT9786V 驅動芯片)	Our Company	September 06, 2024
10. . .	BS245003053	GT5274 Memory Chip (GT5274 儲存芯片)	Our Company	September 06, 2024
11. . .	BS245003061	GT5624 Memory Chip (GT5624 儲存芯片)	Our Company	September 06, 2024
12. . .	BS235009792	GT5266 Memory Chip (GT5266 儲存芯片)	Our Company	January 26, 2024
13. . .	BS235009784	GT5268 Memory Chip (GT5268 儲存芯片)	Our Company	January 26, 2024
14. . .	BS23500927X	GT5255 Temperature Sensor (GT5255 溫度傳感器)	Our Company	January 12, 2024
15. . .	BS23500748X	GT5666 Memory Chip (GT5666 儲存芯片)	Our Company	December 29, 2023

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No.	Registration Number	Composition Design	Composition Design Owner	Issue Date
16...	BS235007463	GT5506 Memory Chip (GT5506 儲存芯片)	Our Company	December 29, 2023
17...	BS235007498	GT5446 Memory Chip (GT5446 儲存芯片)	Our Company	December 29, 2023
18...	BS235007471	GT5504 Memory Chip (GT5504 儲存芯片)	Our Company	December 29, 2023
19...	BS225010844	GT5245 Temperature Sensor (GT5245 溫度傳感器)	Our Company	April 07, 2023
20...	BS225010852	GT9701 Driver Chip (GT9701 驅動芯片)	Our Company	April 07, 2023
21...	BS225000695	GT5263AM2A Memory Chip (GT5263AM2A 儲存芯片)	Our Company	December 16, 2022
22...	BS215017080	GT6001 Temperature Sensor (GT6001 溫度傳感器)	Our Company	December 14, 2022
23...	BS225000687	GT5656CM1A Memory Chip (GT5656CM1A 儲存芯片)	Our Company	December 14, 2022
24...	BS225000709	GT5623 Memory Chip (GT5623 儲存芯片)	Our Company	December 07, 2022
25...	BS22500240X	GT5401 Memory Chip (GT5401 儲存芯片)	Our Company	December 07, 2022
26...	BS225002442	GT9881 Driver Chip (GT9881 驅動芯片)	Our Company	December 07, 2022
27...	BS225000717	GT5263AM1A Memory Chip (GT5263AM1A 儲存芯片)	Our Company	December 02, 2022
28...	BS215009894	GT9778 Driver Chip (GT9778 驅動芯片)	Our Company	January 07, 2022
29...	BS215009886	GT9772V Driver Chip (GT9772V 驅動芯片)	Our Company	January 07, 2022
30...	BS215010612	GT5510 Memory Chip (GT5510 儲存芯片)	Our Company	December 31, 2021
31...	BS21500552X	GT9786 Driver Chip (GT9786 驅動芯片)	Our Company	December 17, 2021
32...	BS205017983	GT9766 Driver Chip (GT9766 驅動芯片)	Our Company	June 04, 2021
33...	BS205017924	GT9769 Driver Chip (GT9769 驅動芯片)	Giantec Semiconductor (Nanjing)	June 04, 2021
34...	BS205017886	GT7701 Driver Chip (GT7701 驅動芯片)	Our Company	June 04, 2021
35...	BS205017991	GT9763 Driver Chip (GT9763 驅動芯片)	Our Company	June 04, 2021
36...	BS215000404	GT5252 Memory Chip (GT5252 儲存芯片)	Our Company	June 04, 2021
37...	BS215000390	GT5256 Memory Chip (GT5256 儲存芯片)	Giantec Semiconductor (Nanjing)	May 28, 2021
38...	BS215000366	7501AMIC Audio Chip (7501AMIC 音頻芯片)	Our Company	May 28, 2021
39...	BS205010105	GT5228 Memory Chip (GT5228 儲存芯片)	Our Company	May 28, 2021
40...	BS215000420	GT5238 Memory Chip (GT5238 儲存芯片)	Giantec Semiconductor (Nanjing)	May 28, 2021
41...	BS205017908	GT5622 Memory Chip (GT5622 儲存芯片)	Our Company	May 28, 2021

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No.	Registration Number	Composition Design	Composition Design Owner	Issue Date
42...	BS205017894	GT5660 Memory Chip (GT5660 儲存芯片)	Our Company	March 24, 2021
43...	BS205017878	GT5652 Memory Chip (GT5652 儲存芯片)	Our Company	March 24, 2021
44...	BS205010113	GT5205 Memory Chip (GT5205 儲存芯片)	Our Company	January 22, 2021
45...	BS205010148	GT5216 Memory Chip (GT5216 儲存芯片)	Our Company	January 22, 2021
46...	BS20501013X	GT5231 Memory Chip (GT5231 儲存芯片)	Our Company	January 22, 2021
47...	BS205010083	GT5224 Memory Chip (GT5224 儲存芯片)	Our Company	January 22, 2021
48...	BS205010091	GT5225 Memory Chip (GT5225 儲存芯片)	Our Company	January 08, 2021
49...	BS205010075	GT5257 Memory Chip (GT5257 儲存芯片)	Our Company	January 08, 2021
50...	BS205010121	GT5202 Memory Chip (GT5202 儲存芯片)	Our Company	January 08, 2021
51...	BS175002304	GT5230 Memory Chip (GT5230 儲存芯片)	Our Company	September 13, 2017
52...	BS175002274	GT9768 Driver Chip (GT9768 驅動芯片)	Our Company	September 13, 2017
53...	BS175002266	GT9767 Driver Chip (GT9767 驅動芯片)	Our Company	September 13, 2017
54...	BS175002282	GT5232 Memory Chip (GT5232 儲存芯片)	Our Company	September 06, 2017
55...	BS175002290	GT2928 Memory Chip (GT2928 儲存芯片)	Our Company	September 06, 2017
56...	BS205017916	GT9764 Driver Chip (GT9764 驅動芯片)	Giantec Semiconductor (Nanjing)	June 04, 2021
57...	BS215000412	GT5239 Memory Chip (GT5239 儲存芯片)	Giantec Semiconductor (Nanjing)	May 28, 2021
58...	BS21500034X	GT5259 Memory Chip (GT5259 儲存芯片)	Giantec Semiconductor (Nanjing)	May 28, 2021
59...	BS215000358	GT5254 Memory Chip (GT5254 儲存芯片)	Giantec Semiconductor (Nanjing)	May 28, 2021
60...	BS245593713	SKAGOS	Shanghai Judong	June 13, 2025
61...	BS245593667	6091W0A	Shanghai Judong	June 13, 2025
62...	BS245593675	8012W1A	Shanghai Judong	June 13, 2025
63...	BS245593683	8032W0A	Shanghai Judong	June 13, 2025
64...	BS245593705	8053W0A	Shanghai Judong	June 13, 2025
65...	BS245593691	8042L0A	Shanghai Judong	June 13, 2025
66...	BS245593659	6091L0A	Shanghai Judong	June 13, 2025
67...	BS235571210	6041W0A	Shanghai Judong	January 19, 2024
68...	BS235571261	whiteharbor	Shanghai Judong	January 19, 2024
69...	BS235571202	60B1W0A	Shanghai Judong	January 19, 2024
70...	BS235571237	8022W0A	Shanghai Judong	January 19, 2024

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No.	Registration Number	Composition Design	Composition Design Owner	Issue Date
71...	BS235571245	8033W0A	Shanghai Judong	January 19, 2024
72...	BS235571253	8042W0A	Shanghai Judong	January 19, 2024
73...	BS235571229	8012W0A	Shanghai Judong	January 19, 2024
74...	BS225614073	6081L0A	Shanghai Judong	July 14, 2023
75...	BS225614057	Kingslanding	Shanghai Judong	July 14, 2023
76...	BS225614065	sisterton	Shanghai Judong	July 14, 2023
77...	BS225571269	barrowton	Shanghai Judong	December 23, 2022
78...	BS215648129	cerwyn	Shanghai Judong	May 20, 2022
79...	BS215648137	holdfast	Shanghai Judong	May 20, 2022
80...	BS215568168	Winterfell	Shanghai Judong	November 19, 2021
81...	BS215568176	Oldtown	Shanghai Judong	November 19, 2021
82 ..	BS265000424	GT5667 Memory Chip (GT5667 儲存芯片)	Our Company	May 11, 2026
83 ..	BS265000432	GT5628 Memory Chip (GT5628 儲存芯片)	Our Company	May 11, 2026

(e) Domain names

As of the Latest Practicable Date, our Group had registered the following domain names which we consider to be or may be material to our business:

No.	Domain Name	Registered Owner	Place of Registration	Registration Date
1 . . .	www.giantec-semi.com	Our Company	PRC	December 20, 2023

C. FURTHER INFORMATION ABOUT OUR DIRECTORS AND SUBSTANTIAL SHAREHOLDERS

1. Particulars of Directors’ Service Contracts and Appointment Letters

We have entered into a service contract or an appointment letter with each of our Directors. The principal particulars of these service contracts and appointment letters include: (a) the term of service; (b) termination provisions in accordance with their respective terms; and (c) a dispute resolution provision. The service contracts and appointment letters may be renewed in accordance with our Articles of Association and the applicable laws, rules, and regulations from time to time.

Save as disclosed above, none of the Directors has or is proposed to have a service contract with any member of our Group (other than contracts expiring or determinable by the relevant employer within one year without the payment of compensation (other than statutory compensation)).

2. Remuneration of Directors

For details of the remuneration of our Directors, see “Directors and Senior Management — Remuneration” and Note 10 of the Accountants’ Report set out in Appendix I.

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3. Disclosure of Interests

(a) *Interests of our Directors and chief executive in our Company*

Save as disclosed below, immediately following the completion of the [REDACTED] and assuming that no new Shares are issued under the [REDACTED] and the Restricted Share Incentive Plans, and no other changes are made to the issued share capital of our Company between the Latest Practicable Date and [REDACTED], so far as our Directors are aware, none of our Directors or the chief executive has any interests and/or short positions in the Shares, underlying Shares, or debentures of our Company or our associated corporations (within the meaning of Part XV of the SFO) which would require (i) notification to our Company and the Stock Exchange under Divisions 7 and 8 of Part XV of the SFO (including interests and/or short positions (as applicable) which they are taken or deemed to have under such provisions of the SFO), (ii) registration in the register under section 352 of the SFO, or (iii) notification to our Company and the Stock Exchange under the Model Code for Securities Transactions by Directors of Listed Issuers as set out in Appendix C3 to the Listing Rules, upon the [REDACTED] of our H Shares on the Stock Exchange.

Name of Director	Position	Shares to be held after the [REDACTED]	Nature of interest ⁽⁴⁾	Number of shares	Approximate % of shareholding in our Company immediately after the [REDACTED] ⁽¹⁾
Mr. CHEN Zuotao ⁽²⁾	Executive Director and Chairman of the Board	A Shares	Interest in controlled corporation	33,414,920	[REDACTED]
Mr. WENG Huaqiang ⁽³⁾ . . .	Executive Director and Secretary of the Board	A Shares	Beneficial owner	68,500	[REDACTED]

Notes:

- (1) The calculation is based on the assumption that the [REDACTED] is not exercised and no changes to our issued and outstanding shares between the Latest Practicable Date and the [REDACTED].
- (2) Mr. CHEN Zuotao is indirectly interested in 33,414,920 A Shares of our Company through Tianhao Technology, which directly owns 33,414,920 A Shares of our Company. Tianhao Investment controls Tianhao Technology and owns approximately 99.99% equity interest in Tianhao Technology. Mr. CHEN Zuoning (陳作寧), brother of Mr. CHEN Zuotao, owns the remaining 0.01% equity interest in Tianhao Technology. Each of Mr. CHEN Zuotao and Mr. CHEN Zuoning owns 99.9% equity interest and 0.1% equity interest in Tianhao Investment, respectively. Each of Mr. CHEN Zuotao, Mr. CHEN Zuoning, Tianhao Technology and Tianhao Investment is deemed to be interested in all the A Shares in which each of them is interested. Mr. CHEN Zuotao, Mr. CHEN Zuoning, Tianhao Technology and Tianhao Investment constitute our Single Largest Group of Shareholders, holding approximately [REDACTED] of the issued share capital of our Company immediately following the completion of the [REDACTED], assuming that the [REDACTED] is not exercised and that no other changes are made to the issued share capital of our Company between the Latest Practicable Date and the [REDACTED].
- (3) Save as disclosed above, Mr. Weng Huaqiang is also entitled to receive up to 29,500 A Shares if and upon the vesting of restricted Shares granted to him under the 2022 Restricted Share Incentive Scheme and 2023 Restricted Share Incentive Scheme, subject to the conditions (including vesting conditions) of those restricted Shares.
- (4) All interests stated are long position.

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(b) *Interests of substantial shareholders*

Save as disclosed below and in the section headed “Substantial Shareholders” in this document, our Directors are not aware of any persons (other than our Directors and chief executive) who will, immediately following the completion of the [REDACTED] and assuming that no new Shares are issued under the [REDACTED] and the Restricted Share Incentive Plans, have or be deemed or taken to have interests and/or short position in our Shares or underlying Shares which would be required to be disclosed under the provisions of Divisions 2 and 3 of Part XV of the SFO, or who is, directly or indirectly, interested in 10% or more of the nominal value of any types of the issued voting shares of any member of our Group.

Name of our subsidiary	Name of substantial shareholder	Approximate % of shareholding in the subsidiary
Shanghai Judong Semiconductor Co., Ltd.* (上海聚棟半導體有限公司)	Shanghai Donglong Microelectronics Co., Ltd.* (上海棟隆微電子 有限公司)	49

4. Disclaimers

Save as disclosed in this section and the section headed “Business” in this document:

- (i) none of our Directors or the chief executive of our Company has any interest or short position in the shares, underlying shares or debentures of our Company or any of its associated corporation (within the meaning of Part XV of the SFO) which will have to be notified to our Company and the Hong Kong Stock Exchange pursuant to Divisions 7 and 8 of Part XV of the SFO or which will be required, pursuant to section 352 of the SFO, to be entered in the register referred to therein, or which will be required to be notified to our Company and the Hong Kong Stock Exchange pursuant to the Model Code for Securities Transactions by Directors of Listed Issuers once the H Shares are [REDACTED];
- (ii) none of our Directors or any of the experts referred to under the paragraph headed “—E. Other Information — 5. Qualifications and Consents of Experts” has any direct or indirect interest in the promotion of our Company, or in any assets which have within the two years immediately preceding the date of this document been acquired or disposed of by or leased to any member of our Group, or are proposed to be acquired or disposed of by or leased to any member of our Group;
- (iii) none of our Directors is materially interested in any contract or arrangement subsisting at the date of this document which is significant in relation to the business of our Group taken as a whole;
- (iv) none of our Directors is materially interested in any contract or arrangement subsisting at the date of this document which is significant in relation to the business of our Group taken as a whole;
- (v) none of our Directors has any existing or proposed service contracts with any member of our Group (excluding contracts expiring or determinable by the employer within one year without payment of compensation (other than statutory compensation));
- (vi) so far as is known to our Directors, no person (not being a Director or chief executive of our Company or any member of our Group) will, immediately following the completion of the [REDACTED], have an interest or short position in the Shares or underlying Shares of our Company which would fall to be disclosed to our Company under the provisions of Divisions 2 and 3 of Part XV of SFO or be interested, directly or indirectly, in 10% or more of the nominal value of any class of share capital carrying rights to vote in all circumstances at general meetings of any member of our Group; and

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- (vii) none of our Directors or their respective close associates (as defined under the Listing Rules) or our Shareholders who are interested in more than 5% of the issued share capital of our Company has any interest in the five largest customers in each year/period during the Track Record Period or the five largest suppliers in each year/period during the Track Record Period of our Group.

D. OUR INCENTIVE PLANS

Restricted Share Incentive Plans

The following is a summary of the principal terms of the 2021 Restricted Share Incentive Plan, the 2022 Restricted Share Incentive Plan, the 2023 Restricted Share Incentive Plan and the 2025 Restricted Share Incentive Plan. Given no further restricted Shares will be granted under the Restricted Share Incentive Plans after the [REDACTED], the terms of the Restricted Share Incentive Plans are not subject to the provisions of Chapter 17 of the Listing Rules.

(i) Purpose

The purpose of the Restricted Share Incentive Plans is to improve our Company’s long-term incentive mechanism, to attract and retain outstanding talents, to motivate our management and key employees and to achieve our strategic development and business objectives. The Restricted Share Incentive Plans are implemented to align the interests of the Shareholders with the interests of our Group and employees which will benefit the sustained development of our Group.

(ii) Administration

The Restricted Share Incentive Plans are subject to approval of the Shareholders’ meeting and administration of the Board.

(iii) Participants

The participants of the Restricted Share Incentive Plans include our management and key employees. The scope of participants excludes independent directors, supervisors of our Company at the relevant time and shareholders or actual controller who individually or collectively hold 5% or more of the A Shares of our Company and their spouse, parents and children.

(iv) Maximum number of Shares

For the Restricted Share Incentive Plans, the Shares underlying the plans shall be A Shares issued by our Company. Each restricted Share granted represents the right to purchase one A Share within the agreed period at the grant price and is subject to a lock-up period. The maximum number of restricted Shares that can be granted under each of the Restricted Shares Incentive Plans are as follows, subject to adjustment as a result of our Company’s equity distribution:

Restricted Share Incentive Plan	Maximum number of restricted Shares to be granted under the plan	Number of restricted Shares to be exercised under the plan
2021 Restricted Share Incentive Plan	900,000 ⁽¹⁾	Nil
2022 Restricted Share Incentive Plan	1,800,000 ⁽¹⁾	67,925
2023 Restricted Share Incentive Plan	1,200,000	513,500
2025 Restricted Share Incentive Plan	1,800,000	1,800,000

(1) Pursuant to the profit distribution and capital reserve conversion plans approved at the 2022 annual general meeting of our Company, three additional Shares from capital reserves were allotted for every 10 Shares held. As a result, the maximum number of restricted Shares to be granted under the 2021 Restricted Share Incentive Plan and the 2022 Restricted Share Incentive Plan have been increased to 1,170,000 and 2,340,000, respectively.

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(v) Date of grant and duration of the incentive plan

The date on which the options are granted shall be a trading day determined by the Board within 60 days after the date of approval of the relevant Restricted Share Incentive Plan by the Shareholders’ meeting. The grant of restricted Shares shall be approved by the Board, registered and announced within 60 days after the approval of the relevant Restricted Share Incentive Plan by the Shareholders’ meeting. The term of each Restricted Share Incentive Plan shall commence from the date of registration of share options granted under the relevant plan and continue until the share options are fully exercised or canceled. This term shall not exceed 72 months.

(vi) Lock-up for Directors and the senior management team

If the grantee is a Director or a senior management of our Company who terminates the employment before expiry of the term, during the period of the original term of employment and the following six months, the Shares to be transferred in each year shall not exceed 25% of the total Shares he or she holds. No Share held by such Director or senior management can be transferred within six months after termination of his or her employment. If the grantee is a Director or senior management of our Company, income gained through sale of Shares within six months of the purchase or purchase of Shares within six months of the sale shall belong to our Company and will be forfeited by the Board. If there is any change in the applicable laws and regulations on the foregoing lock-up requirements, the grantee shall comply with the amended laws and regulations.

(vii) Conditions to the grant of restricted Shares

The restricted Shares will only be granted to selected participants if the following conditions are fulfilled:

- (a) With respect to our Company, none of the following circumstances having occurred:
 - (1) an audit report with an adverse opinion or a disclaimer of opinion has been issued by the reporting accountants with respect to our Company’s accountants’ report for the most recent fiscal year;
 - (2) an audit report with an adverse opinion or a disclaimer of opinion has been issued by the reporting accountant with respect to the internal control report contained in accountants’ report for the most recent fiscal year;
 - (3) our Company has not distributed dividends in accordance with the laws and regulations, our Articles of Association or our public commitment within the last 36 months after its listing;
 - (4) applicable laws and regulations prohibit the implementation of any share incentive plans; or
 - (5) any other circumstances determined by the CSRC.
- (b) With respect to a grantee, none of the following circumstances having occurred:
 - (1) the grantee has been regarded as an inappropriate person by the stock exchange within the last 12 months;
 - (2) the grantee has been regarded as an inappropriate person by the CSRC or its local office within the last 12 months;
 - (3) the grantee has been punished or prohibited from entering into the securities market by the CSRC or its local office within the last 12 months;

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- (4) the grantee is not qualified to serve as a director or senior management according to the PRC Company Law;
- (5) the grantee is prohibited from participating in any incentive plan of listed companies according to applicable laws and regulations; or
- (6) any other circumstances determined by the CSRC.

(viii) Unlocking and vesting of restricted Shares

The lock-up period for the restricted Shares commences from the date of grant to the grantee. The restricted Shares will only be unlocked when (i) the grant conditions set out in the Restricted Share Incentive Plans are fulfilled; and (ii) the corresponding annual company performance targets and individual performance assessments as set out under the relevant Restricted Share Incentive Plans are achieved.

Subject to the satisfaction of all vesting conditions, the restricted Shares will be unlocked and vest in four equal installments of 25% each (except for the 2021 Restricted Share Incentive Plan, which has a vesting schedule of 10%, 50%, 30% and 10% across four periods). The vesting periods occur between the first trading day after the 12-month, 24-month, 36-month, and 48-month anniversaries of the grant date and the last trading day up to the 24-month, 36-month, 48-month, and 60-month anniversaries of the grant date, respectively.

The grantees shall pay the grant price to the Company upon the vesting of the restricted Shares. The grant price per restricted Share under each Plan is determined as follows:

- (a) **2021 Restricted Share Incentive Plan:** RMB22.64 per Share, being 50% of the average trading price of the A Shares on the trading day immediately preceding the announcement of the draft plan;
- (b) **2022 Restricted Share Incentive Plan:** RMB22.64 per share, being 34.48% of the average trading price of the A Shares on the trading day immediately preceding the announcement of the draft plan;
- (c) **2023 Restricted Share Incentive Plan:** RMB27.60 per Share, being 50% of the average trading price of the A Shares on the trading day immediately preceding the announcement of the draft plan;
- (d) **2025 Restricted Share Incentive Plan:** RMB48.00 per Share, being not less than the higher of: (i) 50% of the average trading price of the A Shares on the trading day immediately preceding the announcement of the draft plan; (ii) 50% of the average trading price of the A Shares over the 20 trading days preceding the announcement of the draft plan; (iii) 50% of the average trading price of the A Shares over the 60 trading days preceding the announcement of the draft plan; and (iv) 50% of the average trading price of the A Shares over the 120 trading days preceding the announcement.

The grant price for any reserved portion of restricted Shares under each plan is the same as that for the initial grant.

The vesting date shall be on a trading day, which shall not fall within the following periods (i) 15 days before the publication of the annual report or interim report, or, if the publication date of such report is postponed, the period commencing 30 days before the originally scheduled announcement date until one day before the actual publication; (ii) 5 days before the publication of the Company’s quarterly report, earnings forecast, or preliminary earnings announcement; (iii) the period commencing on the date of occurrence of a major event that may materially affect the Company’s share price or the date such event enters the decision-making process, until the date of lawful disclosure of such event; and (iv) any other period as stipulated by the CSRC or the Shanghai Stock Exchange.

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The grantees must satisfy the vesting conditions and complete the vesting of their restricted Shares within the validity period of the respective Restricted Share Incentive Plans. The Company may cause the forfeiture and cancellation of unvested restricted Shares, or in certain circumstances repurchase vested Shares, upon the occurrence of specific events as set out in the Plans, including but not limited to a termination of the grantee’s employment or a change in the grantee’s position that renders them ineligible. Subject to the price adjustment mechanisms and other terms of the Restricted Share Incentive Plans, the repurchase price payable by the Company for vested restricted Shares shall be the original grant price paid by the grantee.

(ix) Outstanding restricted Shares

As of the Latest Practicable Date, there is no outstanding restricted Shares granted under the 2021 Restricted Share Incentive Plan and the number of outstanding restricted Shares granted under the 2022 Restricted Share Incentive Plan, the 2023 Restricted Share Incentive Plan and the 2025 Restricted Share Incentive Plan amounted to 67,925 Shares, 513,500 Shares and 1,800,000 Shares, representing approximately [REDACTED], [REDACTED] and [REDACTED] respectively of the issued Shares immediately following the completion of the [REDACTED] (assuming no changes to our issued and outstanding shares between the Latest Practicable Date and the [REDACTED]).

Assuming full vesting and exercise of all outstanding restricted Shares under the Restricted Share Incentive Plans, the shareholding of our Shareholders immediately following completion of the [REDACTED] (assuming that no changes are made to the issued share capital of our Company between the Latest Practicable Date and the [REDACTED]) will be diluted by a maximum of approximately [REDACTED]. The maximum dilution effect on our earnings per share would be approximately [REDACTED]. For further details on the diluted earnings per share, including the relevant assumptions used in that calculation, please refer to Note 14 to the Accountants’ Report set out in Appendix I to this document.

The tables below set forth the details of the outstanding restricted Shares granted to Directors, senior management members, and other connected persons under the Restricted Share Incentive Plans as of the Latest Practicable Date:

(a) 2022 Restricted Share Incentive Plan

Name of the grantee	Position in the Group	Date of grant	Address	Number of outstanding restricted Shares	Grant price (RMB)	Approximate percentage of issued Shares immediately after completion of the [REDACTED]
Mr. Weng Huaqiang	Executive Director and Secretary of the Board	August 24, 2022	Room 202, No. 53, Lane 36, Shangpu Road, Pudong New Area, Shanghai, China	19,500	15.33	[REDACTED]

(b) 2023 Restricted Share Incentive Plan

Name of the grantee	Position in the Group	Date of grant	Address	Number of outstanding restricted Shares	Grant price (RMB)	Approximate percentage of issued Shares immediately after completion of the [REDACTED]
Mr. Weng Huaqiang	Executive Director and Secretary of the Board	October 18, 2023	Room 202, No. 53, Lane 36, Shangpu Road, Pudong New Area, Shanghai, China	10,000	26.40	[REDACTED]

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The table below sets forth the details of outstanding restricted Shares granted to other grantees (excluding Directors, senior management and connected persons of our Company) under the Restricted Share Incentive Plans as of the Latest Practicable Date:

(a) 2021 Restricted Share Incentive Plan

<u>Number of grantees</u>	<u>Date of grant</u>	<u>Grant price</u> <i>(RMB)</i>	<u>Number of outstanding restricted Shares</u>	<u>Approximate percentage of issued Shares immediately after completion of the [REDACTED]</u>
3	December 27, 2021	15.72	Nil	[REDACTED]

(b) 2022 Restricted Share Incentive Plan

<u>Number of grantees</u>	<u>Date of grant</u>	<u>Grant price</u> <i>(RMB)</i>	<u>Number of outstanding restricted Shares</u>	<u>Approximate percentage of issued Shares immediately after completion of the [REDACTED]</u>
19	August 24, 2022	15.33	67,925	[REDACTED]

(c) 2023 Restricted Share Incentive Plan

<u>Number of grantees</u>	<u>Date of grant</u>	<u>Grant price</u> <i>(RMB)</i>	<u>Number of outstanding restricted Shares</u>	<u>Approximate percentage of issued Shares immediately after completion of the [REDACTED]</u>
58	October 18, 2023	26.40	492,600	[REDACTED]
1	October 18, 2023	26.40	7,500	[REDACTED]
5	April 29, 2024	26.40	13,400	[REDACTED]

(d) 2025 Restricted Share Incentive Plan

<u>Number of grantees</u>	<u>Date of grant</u>	<u>Grant price</u> <i>(RMB)</i>	<u>Number of outstanding restricted Shares</u>	<u>Approximate percentage of issued Shares immediately after completion of the [REDACTED]</u>
56	October 22, 2025	48.00	1,612,000	[REDACTED]
16	October 22, 2025	48.00	135,000	[REDACTED]
5	March 20, 2026	48.00	53,000	[REDACTED]

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E. OTHER INFORMATION

1. Estate Duty

Our Directors have been advised that no material liability for estate duty under PRC laws is expected to be imposed on any member of our Group.

2. Litigation

To the knowledge of our Directors, no member of our Group has significant litigation or claims pending or threatened against any member of our Group.

3. Sole Sponsor

The Sole Sponsor has made an application on behalf of our Company to the [REDACTED] for the [REDACTED] of, and permission to [REDACTED], the H Shares of our Company. All necessary arrangements have been made enabling the H Shares to be admitted into [REDACTED].

The Sole Sponsor satisfies the independence criteria set out in Rule 3A.07 of the Listing Rules.

Pursuant to the engagement letter entered into between our Company and the Sole Sponsor, we have agreed to pay the Sole Sponsor a fee of US\$500,000 to act as a sponsor of our Company in connection with the [REDACTED].

4. Compliance Advisor

Our Company has appointed Altus Capital Limited as our Compliance Advisor in compliance with Rule 3A.19 of the Listing Rules.

5. Qualifications and Consents of Experts

The qualifications of the experts, as defined under the Listing Rules, who have given opinions in this document are as follows:

Name	Qualifications
China International Capital Corporation Hong Kong Securities Limited	Licensed to conduct Type 1 (dealing in securities), Type 2 (dealing in futures contracts), Type 4 (advising on securities), Type 5 (advising on futures contracts) and Type 6 (advising on corporate finance) regulated activities under the SFO
Global Law Office	Legal advisor to our Company as to PRC laws
Ernst & Young	Certified Public Accountants and Registered Public Interest Entity Auditor
Frost & Sullivan (Beijing) Inc., Shanghai Branch Co.	Independent industry consultant
DLA Piper Singapore Pte. Ltd.	Legal advisors to the Company as to International Sanctions laws

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Each expert listed above has provided, and not withdrawn, their written consent to the issue of this document, including their reports, letters, opinions, or summaries thereof, and to the inclusion of their name and qualifications herein, in the form and context in which each is included.

As of the Latest Practicable Date, none of the aforementioned experts had any shareholding in any member of our Group or the right (whether legally enforceable or not) to subscribe for, or nominate persons to subscribe for, securities in any member of our Group.

6. Binding Effect

This document shall, if an application is made in pursuance thereof, render all persons concerned bound by all the provisions (other than the penal provisions) of sections 44A and 44B of the Companies (Winding Up and Miscellaneous Provisions) Ordinance, insofar as applicable.

7. No Material Adverse Change

Our Directors confirm that there has been no material adverse change in our Company’s financial or [REDACTED] position since March 31, 2026 (being the latest balance sheet date of our consolidated financial statements set out in the Accountants’ Report in Appendix I to this document).

8. Bilingual Document

The English and Chinese language versions of this document are being published separately in reliance on the exemption provided by section 4 of the Companies (Exemption of Companies and Prospectuses from Compliance with Provisions) Notice (Chapter 32L of the Laws of Hong Kong).

9. Preliminary Expenses

As of the Latest Practicable Date, our Company did not incur any material preliminary expenses.

10. Restrictions on Share Repurchase

For details of the restrictions on share repurchases by our Company, please refer to “Summary of the Articles of Association — Increase, Reduction and Repurchase of Shares” in Appendix III to this document.

11. Taxation of Holders of H Shares

The sale, purchase and transfer of H Shares are subject to Hong Kong stamp duty. The current rate charged on each of the seller and purchaser is 0.1% of the consideration or, if higher, the fair value of the H Shares being sold or transferred.

12. Promoters

Within two years immediately preceding the date of this document, no cash, securities or other benefit has been paid, allotted or given nor is any proposed to be paid, allotted or given to any promoters in connection with the [REDACTED] and the related transactions described in this document.

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13. Miscellaneous

Save as disclosed in this section and in the section headed “Financial Information” in this document:

- (i) within the two years immediately preceding the date of this document:
 - (a) no share or loan capital of our Company or any of our subsidiaries had been issued or agreed to be issued or proposed to be fully or partly paid either for cash or a consideration other than cash;
 - (b) no share or loan capital of our Company or any of our subsidiaries had been under option or is agreed conditionally or unconditionally to be put under option;
 - (c) no commissions, discounts, brokerages or other special terms had been granted or agreed to be granted in connection with the issue or sale of any share or loan capital of our Company or any of our subsidiaries; and
 - (d) no commission had been paid or payable for subscription, agreeing to subscribe, procuring subscription or agreeing to procure subscription of any share in our Company or any of our subsidiaries;
- (ii) there are no founder, management or deferred shares, convertible debt securities nor any debentures in our Company or any of our subsidiaries;
- (iii) there has not been any interruption in the business of our Group which may have or has had a significant effect on the financial position of our Group in the 12 months preceding the date of this document;
- (iv) our Company has no outstanding convertible debt securities or debentures;
- (v) there is no arrangement under which future dividends are waived or agreed to be waived;
- (vi) save for the A Shares of our Company that are listed on the Shanghai Stock Exchange, and save for the H Shares to be issued in connection with the [REDACTED], none of the equity and debt securities of our Company, if any, is listed or dealt with in any other stock exchange nor is any [REDACTED] or permission to [REDACTED] being or proposed to be sought; and
- (vii) all necessary arrangements have been made to enable the H shares to be admitted into [REDACTED] for [REDACTED] and [REDACTED].